

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Satoshi EBATO</td> <td>05/07/2008</td> </tr> <tr> <td>Kenji TSUSHIO</td> <td>04/21/2008</td> </tr> <tr> <td>Tatsuhito TABUCHI</td> <td>04/14/2008</td> </tr> <tr> <td>Kou KOBAYASHI</td> <td>04/14/2008</td> </tr> <tr> <td>Yoshihito OKIZAKI</td> <td>04/14/2008</td> </tr> <tr> <td>Shigeru MASUDA</td> <td>05/13/2008</td> </tr> </tbody> </table>		Name	Execution Date	Satoshi EBATO	05/07/2008	Kenji TSUSHIO	04/21/2008	Tatsuhito TABUCHI	04/14/2008	Kou KOBAYASHI	04/14/2008	Yoshihito OKIZAKI	04/14/2008	Shigeru MASUDA	05/13/2008
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Shigeru MASUDA	05/13/2008														
RECEIVING PARTY DATA															
Name:	SONY CORPORATION														
Street Address:	1-7-1 Konan, Minato-ku														
City:	Tokyo														
State/Country:	Japan														
Postal Code:	108-0075														
PROPERTY NUMBERS Total: 1															
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12043366</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12043366										
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Application Number:	12043366														
CORRESPONDENCE DATA															
Fax Number:	(703)413-2220														
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ATTORNEY DOCKET NUMBER:	323244US8														
NAME OF SUBMITTER:	Aynalem Assefa														

OP \$40.00 12043366

Total Attachments: 2

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ASSIGNMENT

Docket Number: 323244US8

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in INFORMATION PROCESSING APPARATUS, IMAGING APPARATUS, IMAGE DISPLAY CONTROL METHOD AND COMPUTER PROGRAM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 1-7-1 Konan, Minato-Ku, Tokyo, 108-0075 Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 12/043,366
Filing Date: March 6, 2008

This assignment executed on the dates indicated below.

Satoshi EBATO

Name of first or sole inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of first or sole inventor

Satoshi Ebato

Signature of first or sole inventor

May 7, 2008

Date of this assignment

Kenji TSUSHIO

Name of second inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of second inventor

Kenji Tsushio
Signature of second inventor

April 21, 2008
Date of this assignment

Tatsuhito TABUCHI

Name of third inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of third inventor

Tatsuhito Tabuchi
Signature of third inventor

April 14, 2008
Date of this assignment

Kou KOBAYASHI

Name of fourth inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of fourth inventor

Kou Kobayashi
Signature of fourth inventor

April 14, 2008
Date of this assignment

Yoshihito OKIZAKI

Name of fifth inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of fifth inventor

Yoshihito Okizaki
Signature of fifth inventor

April 14, 2008
Date of this assignment

Shigeru MASUDA

Name of sixth inventor

Execution date of U.S. Patent Application

Kanagawa, Japan

Residence of sixth inventor

Shigeru Masuda
Signature of sixth inventor

May 13, 2008
Date of this assignment